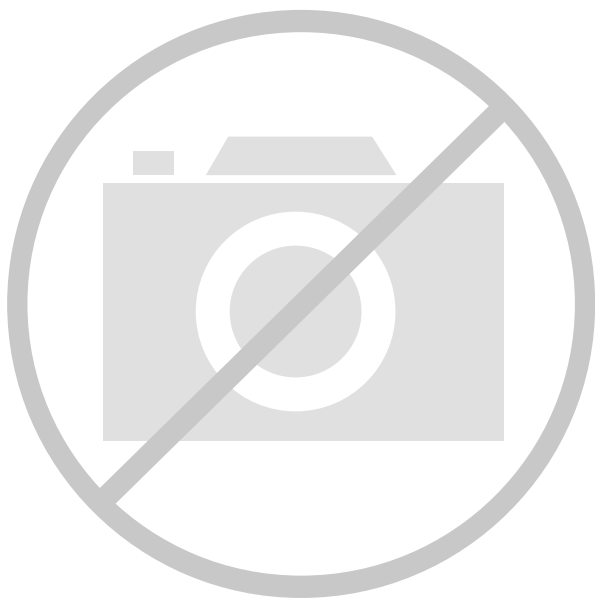




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Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

Product Status	Obsolete
Programmable Type	In-System Reprogrammable™ (ISR™) CMOS
Delay Time tpd(1) Max	15 ns
Voltage Supply - Internal	4.75V ~ 5.25V
Number of Logic Elements/Blocks	-
Number of Macrocells	512
Number of Gates	-
Number of I/O	197
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	292-BGA
Supplier Device Package	292-PBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy37512p256-83bgc

The buried macrocell also supports input register capability. The buried macrocell can be configured to act as an input register (D-type or latch) whose input comes from the I/O pin associated with the neighboring macrocell. The output of all buried macrocells is sent directly to the PIM regardless of its configuration.

I/O Macrocell

Figure 2 illustrates the architecture of the I/O macrocell. The I/O macrocell supports the same functions as the buried macrocell with the addition of I/O capability. At the output of the macrocell, a polarity control mux is available to select active LOW or active HIGH signals. This has the added advantage of allowing significant logic reduction to occur in many applications.

The Ultra37000 macrocell features a feedback path to the PIM separate from the I/O pin input path. This means that if the macrocell is buried (fed back internally only), the associated I/O pin can still be used as an input.

Bus Hold Capabilities on all I/Os

Bus-hold, which is an improved version of the popular internal pull-up resistor, is a weak latch connected to the pin that does not degrade the device's performance. As a latch, bus-hold maintains the last state of a pin when the pin is placed in a high-impedance state, thus reducing system noise in bus-interface applications. Bus-hold additionally allows unused device pins to remain unconnected on the board, which is particularly useful during prototyping as designers can route new signals to the device without cutting trace connections to V_{CC} or GND. For more information, see the application note *Understanding Bus-Hold—A Feature of Cypress CPLDs*.

Programmable Slew Rate Control

Each output has a programmable configuration bit, which sets the output slew rate to fast or slow. For designs concerned with meeting FCC emissions standards the slow edge provides for lower system noise. For designs requiring very high performance the fast edge rate provides maximum system performance.

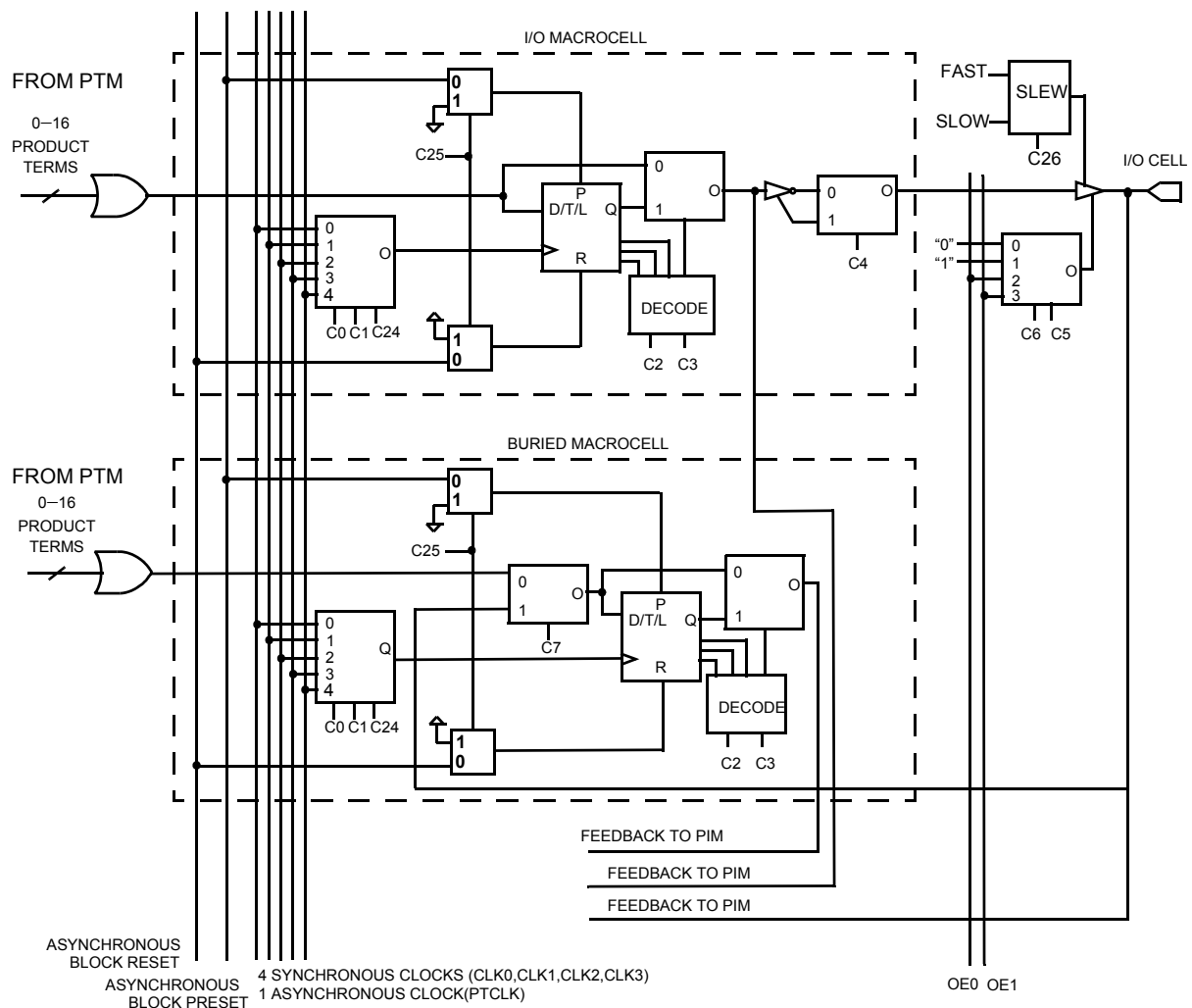
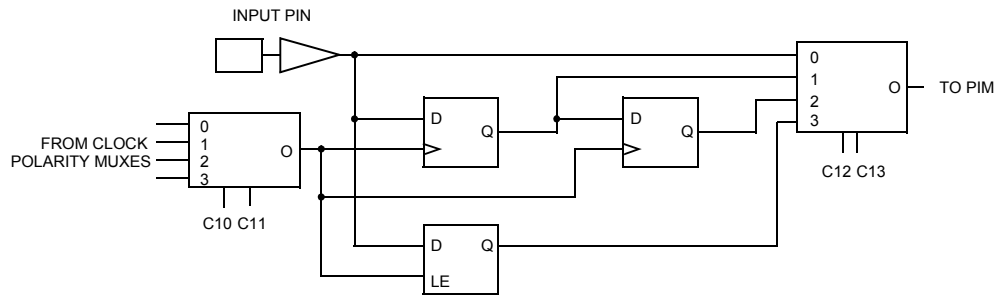
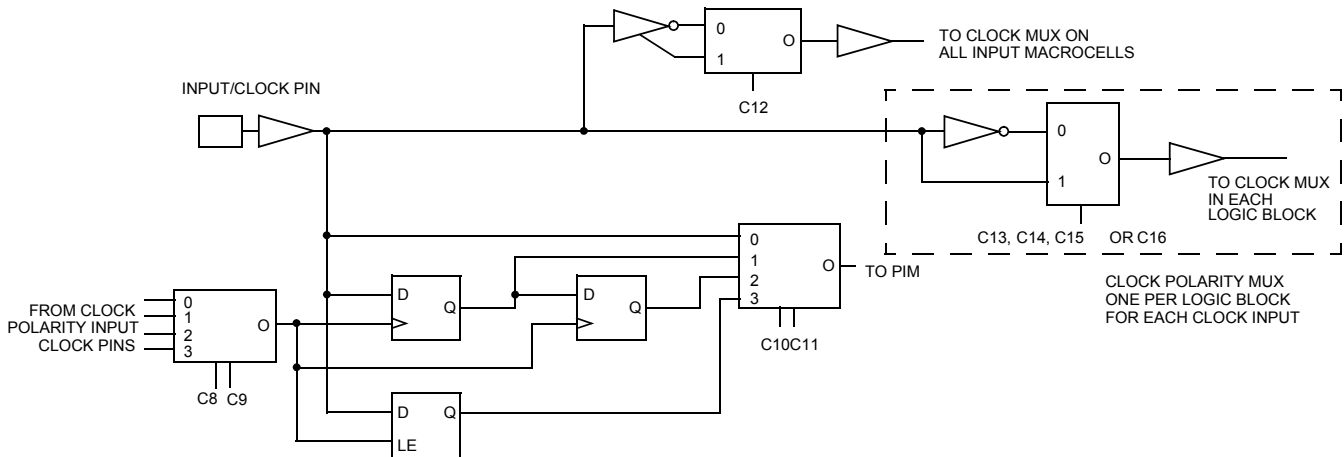


Figure 2. I/O and Buried Macrocells


Figure 3. Input Macrocell

Figure 4. Input/Clock Macrocell

Clocking

Each I/O and buried macrocell has access to four synchronous clocks (CLK0, CLK1, CLK2 and CLK3) as well as an asynchronous product term clock PTCLK. Each input macrocell has access to all four synchronous clocks.

Dedicated Inputs/Clocks

Five pins on each member of the Ultra37000 family are designated as input-only. There are two types of dedicated inputs on Ultra37000 devices: input pins and input/clock pins. *Figure 3* illustrates the architecture for input pins. Four input options are available for the user: combinatorial, registered, double-registered, or latched. If a registered or latched option is selected, any one of the input clocks can be selected for control.

Figure 4 illustrates the architecture for the input/clock pins. Like the input pins, input/clock pins can be combinatorial, registered, double-registered, or latched. In addition, these pins feed the clocking structures throughout the device. The clock path at the input has user-configurable polarity.

Product Term Clocking

In addition to the four synchronous clocks, the Ultra37000 family also has a product term clock for asynchronous clocking. Each logic block has an independent product term clock which is available to all 16 macrocells. Each product term clock also supports user configurable polarity selection.

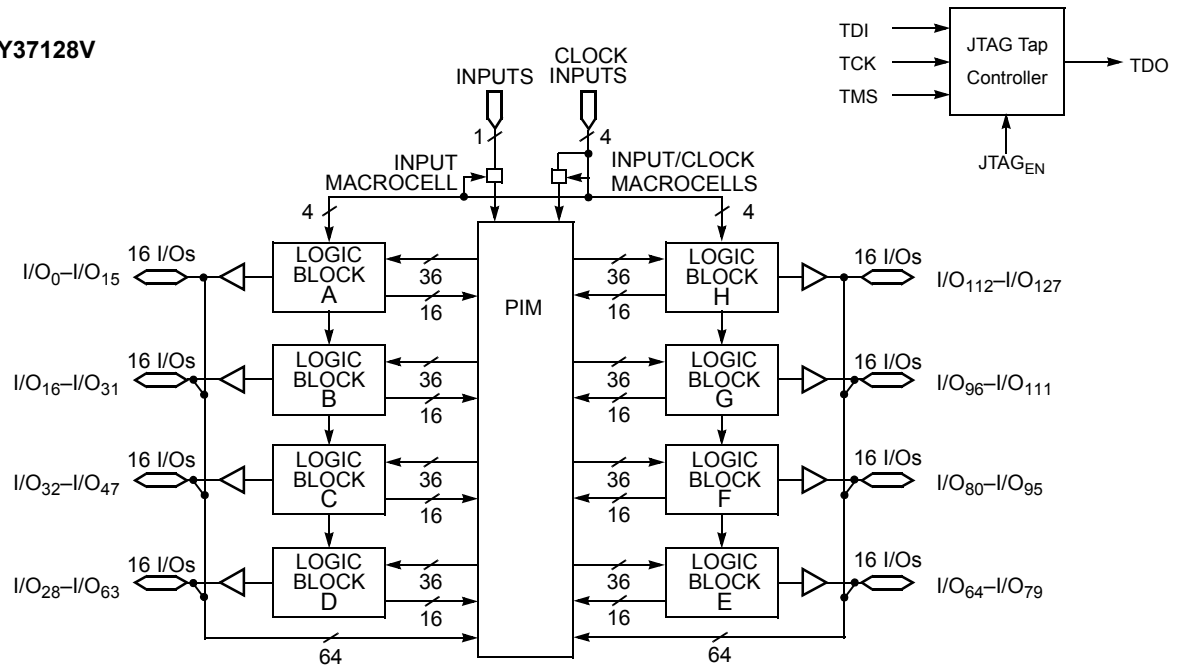
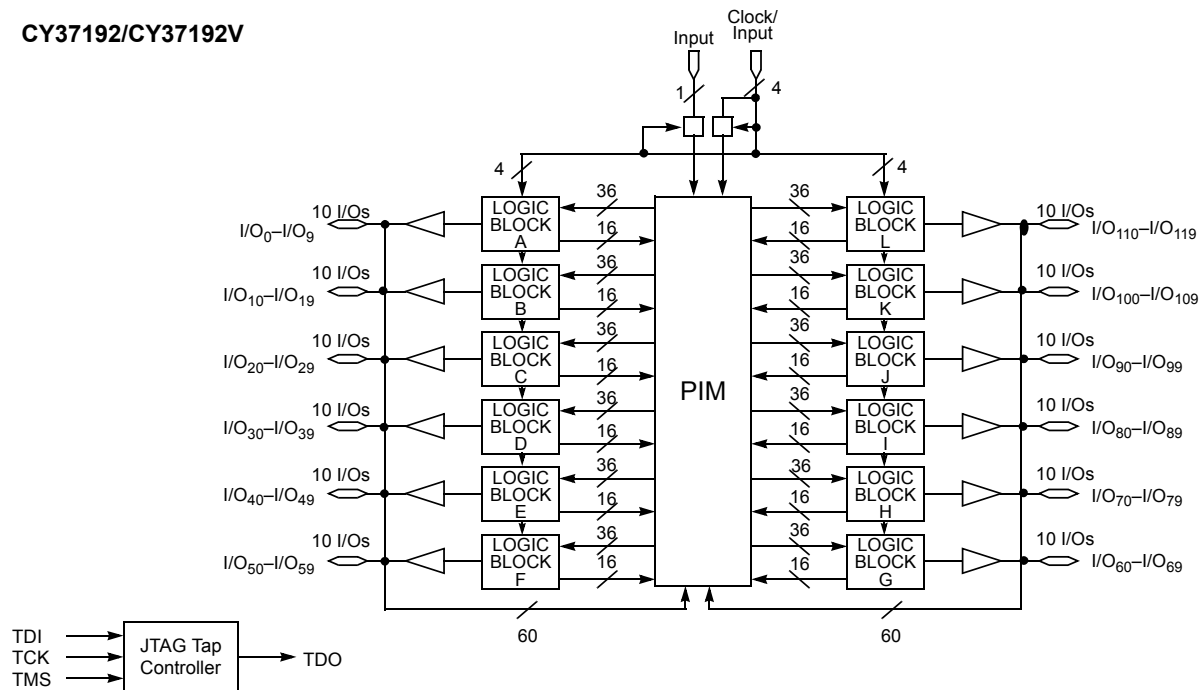
Timing Model

One of the most important features of the Ultra37000 family is the simplicity of its timing. All delays are worst case and system performance is unaffected by the features used. *Figure 5* illustrates the true timing model for the 167-MHz devices in high speed mode. For combinatorial paths, any input to any output incurs a 6.5-ns worst-case delay regardless of the amount of logic used. For synchronous systems, the input set-up time to the output macrocells for any input is 3.5 ns and the clock to output time is also 4.0 ns. These measurements are for any output and synchronous clock, regardless of the logic used.

The Ultra37000 features:

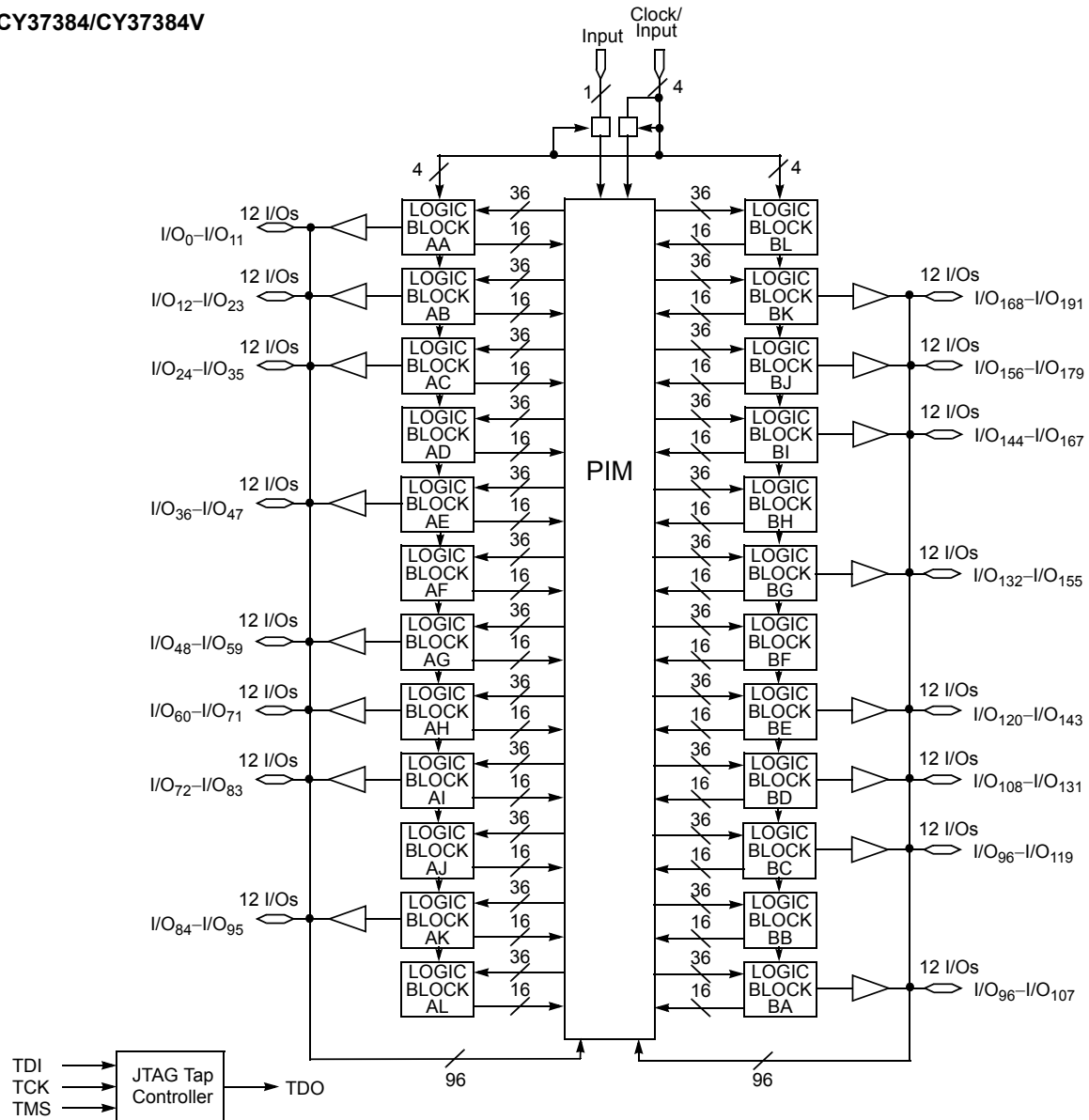
- No fanout delays
- No expander delays
- No dedicated vs. I/O pin delays
- No additional delay through PIM
- No penalty for using 0–16 product terms
- No added delay for steering product terms
- No added delay for sharing product terms
- No routing delays
- No output bypass delays

The simple timing model of the Ultra37000 family eliminates unexpected performance penalties.

Logic Block Diagrams (continued)
CY37128/CY37128V

CY37192/CY37192V


Logic Block Diagrams (continued)

CY37384/CY37384V



Inductance^[5]

Parameter	Description	Test Conditions	44-Lead TQFP	44-Lead PLCC	44-Lead CLCC	84-Lead PLCC	84-Lead CLCC	100-Lead TQFP	160-Lead TQFP	208-Lead PQFP	Unit
L	Maximum Pin Inductance	$V_{IN} = 5.0V$ at $f = 1\text{ MHz}$	2	5	2	8	5	8	9	11	nH

Capacitance^[5]

Parameter	Description	Test Conditions	Max.	Unit
$C_{I/O}$	Input/Output Capacitance	$V_{IN} = 5.0V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	10	pF
C_{CLK}	Clock Signal Capacitance	$V_{IN} = 5.0V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	12	pF
C_{DP}	Dual-Function Pins ^[9]	$V_{IN} = 5.0V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	16	pF

Endurance Characteristics^[5]

Parameter	Description	Test Conditions	Min.	Typ.	Unit
N	Minimum Reprogramming Cycles	Normal Programming Conditions ^[2]	1,000	10,000	Cycles

3.3V Device Characteristics
Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature $-65^\circ C$ to $+150^\circ C$

Ambient Temperature with

Power Applied $-55^\circ C$ to $+125^\circ C$

Supply Voltage to Ground Potential $-0.5V$ to $+4.6V$

DC Voltage Applied to Outputs

in High-Z State $-0.5V$ to $+7.0V$

DC Input Voltage $-0.5V$ to $+7.0V$

DC Program Voltage 3.0 to $3.6V$

Current into Outputs 8 mA

Static Discharge Voltage $> 2001V$
(per MIL-STD-883, Method 3015)

Latch-up Current $> 200\text{ mA}$

Operating Range^[2]

Range	Ambient Temperature ^[2]	Junction Temperature	V_{CC} ^[10]
Commercial	$0^\circ C$ to $+70^\circ C$	$0^\circ C$ to $+90^\circ C$	$3.3V \pm 0.3V$
Industrial	$-40^\circ C$ to $+85^\circ C$	$-40^\circ C$ to $+105^\circ C$	$3.3V \pm 0.3V$
Military ^[3]	$-55^\circ C$ to $+125^\circ C$	$-55^\circ C$ to $+130^\circ C$	$3.3V \pm 0.3V$

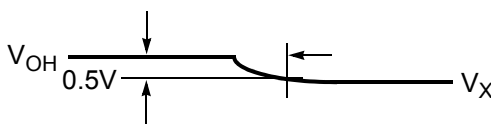
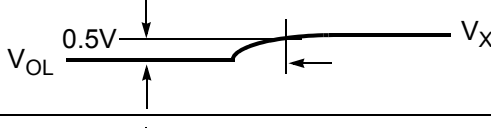
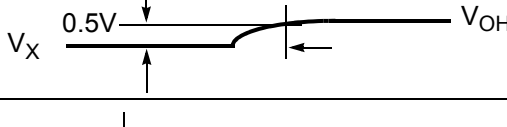
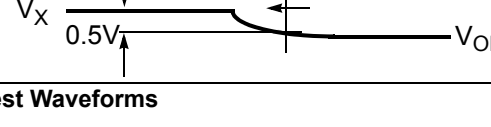
3.3V Device Electrical Characteristics Over the Operating Range

Parameter	Description	Test Conditions	Min.	Max.	Unit
V_{OH}	Output HIGH Voltage	$V_{CC} = \text{Min.}$ $I_{OH} = -4\text{ mA (Com'I)}^{[4]}$ $I_{OH} = -3\text{ mA (Mil)}^{[4]}$	2.4		V
V_{OL}	Output LOW Voltage	$V_{CC} = \text{Min.}$ $I_{OL} = 8\text{ mA (Com'I)}^{[4]}$ $I_{OL} = 6\text{ mA (Mil)}^{[4]}$		0.5	V
V_{IH}	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs ^[7]	2.0	5.5	V
V_{IL}	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs ^[7]	-0.5	0.8	V
I_{IX}	Input Load Current	$V_I = \text{GND OR } V_{CC}$, Bus-Hold Disabled	-10	10	μA
I_{OZ}	Output Leakage Current	$V_O = \text{GND or } V_{CC}$, Output Disabled, Bus-Hold Disabled	-50	50	μA
I_{OS}	Output Short Circuit Current ^[5, 8]	$V_{CC} = \text{Max.}$, $V_{OUT} = 0.5V$	-30	-160	mA
I_{BHL}	Input Bus-Hold LOW Sustaining Current	$V_{CC} = \text{Min.}$, $V_{IL} = 0.8V$	+75		μA
I_{BHH}	Input Bus-Hold HIGH Sustaining Current	$V_{CC} = \text{Min.}$, $V_{IH} = 2.0V$	-75		μA
I_{BHLO}	Input Bus-Hold LOW Overdrive Current	$V_{CC} = \text{Max.}$		+500	μA
I_{BHHO}	Input Bus-Hold HIGH Overdrive Current	$V_{CC} = \text{Max.}$		-500	μA

Notes:

9. Dual pins are I/O with JTAG pins.

10. For CY37064VP100-143AC, CY37064VP100-143BBC, CY37064VP44-143AC, CY37064VP48-143BAC; Operating Range: V_{CC} is $3.3V \pm 0.16V$.

Parameter ^[11]	V _X	Output Waveform—Measurement Level
t _{ER} (-)	1.5V	
t _{ER} (+)	2.6V	
t _{EA} (+)	1.5V	
t _{EA} (-)	V _{the}	

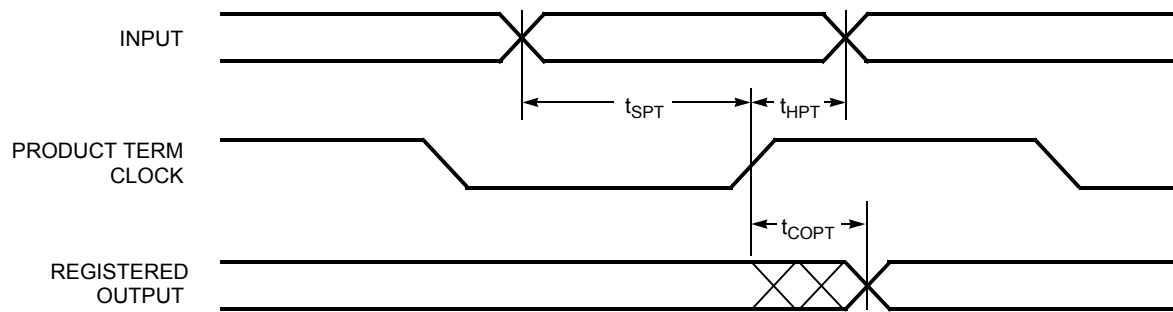
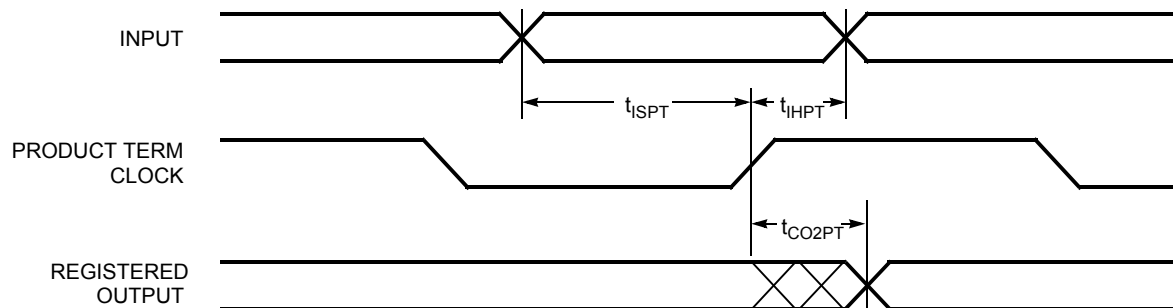
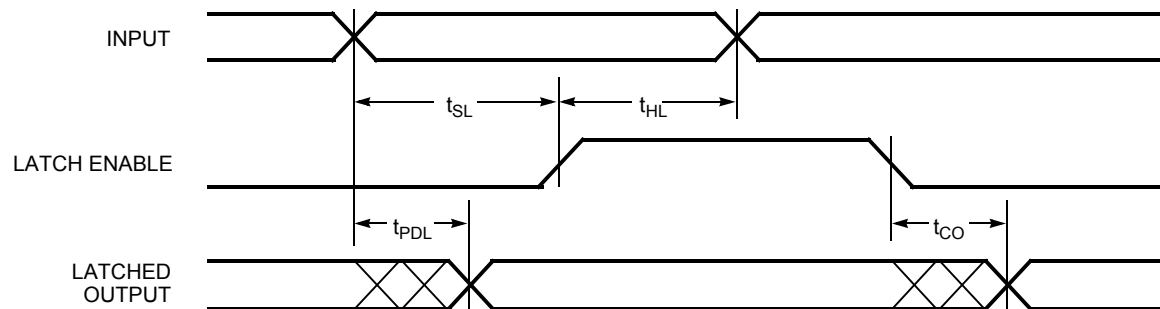
(d) Test Waveforms

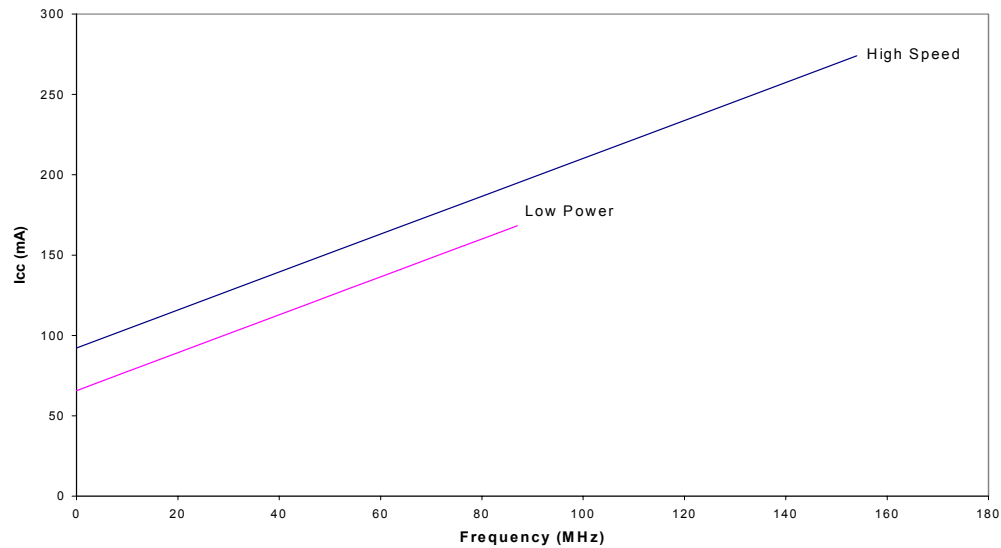
Switching Characteristics Over the Operating Range ^[12]

Parameter	Description	Unit
Combinatorial Mode Parameters		
t _{PD} ^[13, 14, 15]	Input to Combinatorial Output	ns
t _{PDL} ^[13, 14, 15]	Input to Output Through Transparent Input or Output Latch	ns
t _{PDLL} ^[13, 14, 15]	Input to Output Through Transparent Input and Output Latches	ns
t _{EA} ^[13, 14, 15]	Input to Output Enable	ns
t _{ER} ^[11, 13]	Input to Output Disable	ns
Input Register Parameters		
t _{WL}	Clock or Latch Enable Input LOW Time ^[8]	ns
t _{WH}	Clock or Latch Enable Input HIGH Time ^[8]	ns
t _{IS}	Input Register or Latch Set-up Time	ns
t _{IH}	Input Register or Latch Hold Time	ns
t _{CO} ^[13, 14, 15]	Input Register Clock or Latch Enable to Combinatorial Output	ns
t _{COL} ^[13, 14, 15]	Input Register Clock or Latch Enable to Output Through Transparent Output Latch	ns
Synchronous Clocking Parameters		
t _{CO} ^[14, 15]	Synchronous Clock (CLK ₀ , CLK ₁ , CLK ₂ , or CLK ₃) or Latch Enable to Output	ns
t _S ^[13]	Set-Up Time from Input to Sync. Clk (CLK ₀ , CLK ₁ , CLK ₂ , or CLK ₃) or Latch Enable	ns
t _H	Register or Latch Data Hold Time	ns
t _{CO2} ^[13, 14, 15]	Output Synchronous Clock (CLK ₀ , CLK ₁ , CLK ₂ , or CLK ₃) or Latch Enable to Combinatorial Output Delay (Through Logic Array)	ns
t _{SCS} ^[13]	Output Synchronous Clock (CLK ₀ , CLK ₁ , CLK ₂ , or CLK ₃) or Latch Enable to Output Synchronous Clock (CLK ₀ , CLK ₁ , CLK ₂ , or CLK ₃) or Latch Enable (Through Logic Array)	ns
t _{SL} ^[13]	Set-Up Time from Input Through Transparent Latch to Output Register Synchronous Clock (CLK ₀ , CLK ₁ , CLK ₂ , or CLK ₃) or Latch Enable	ns
t _{HL}	Hold Time for Input Through Transparent Latch from Output Register Synchronous Clock (CLK ₀ , CLK ₁ , CLK ₂ , or CLK ₃) or Latch Enable	ns

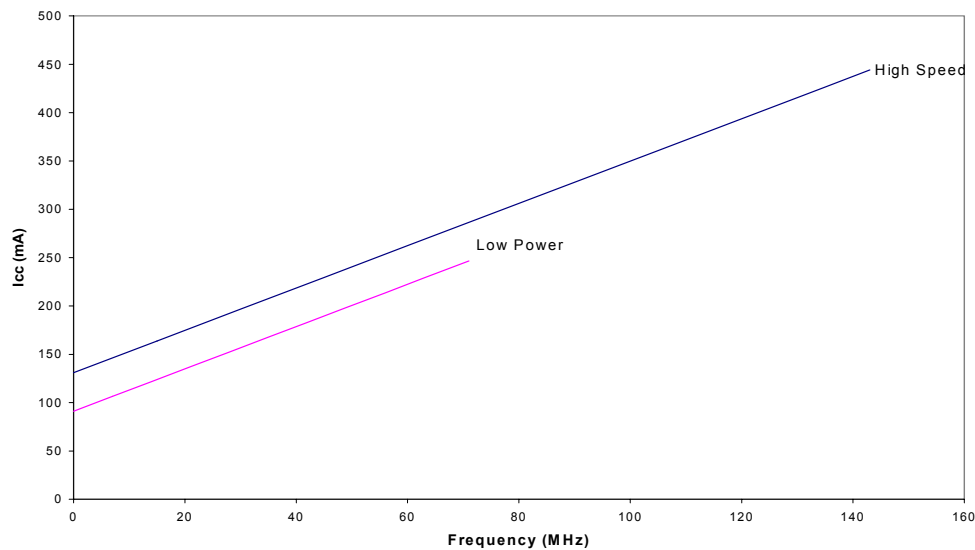
Notes:

11. t_{ER} measured with 5-pF AC Test Load and t_{EA} measured with 35-pF AC Test Load.
12. All AC parameters are measured with two outputs switching and 35-pF AC Test Load.
13. Logic Blocks operating in Low-Power Mode, add t_{LP} to this spec.
14. Outputs using Slow Output Slew Rate, add t_{SLEW} to this spec.
15. When V_{CCO} = 3.3V, add t_{3.3IO} to this spec.

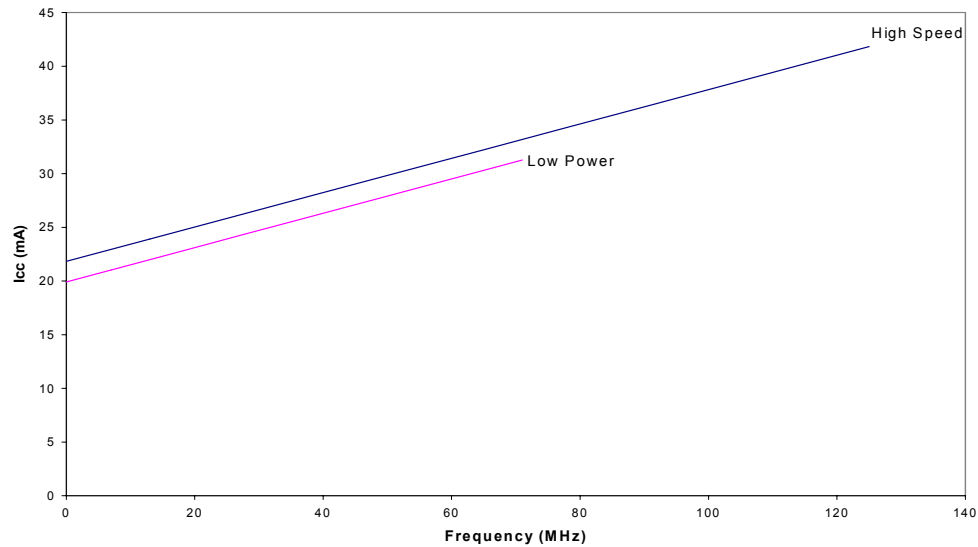
Switching Waveforms (continued)
Registered Output with Product Term Clocking Input Going Through the Array

Registered Output with Product Term Clocking Input Coming From Adjacent Buried Register

Latched Output


Typical 5.0V Power Consumption (continued)
CY37256


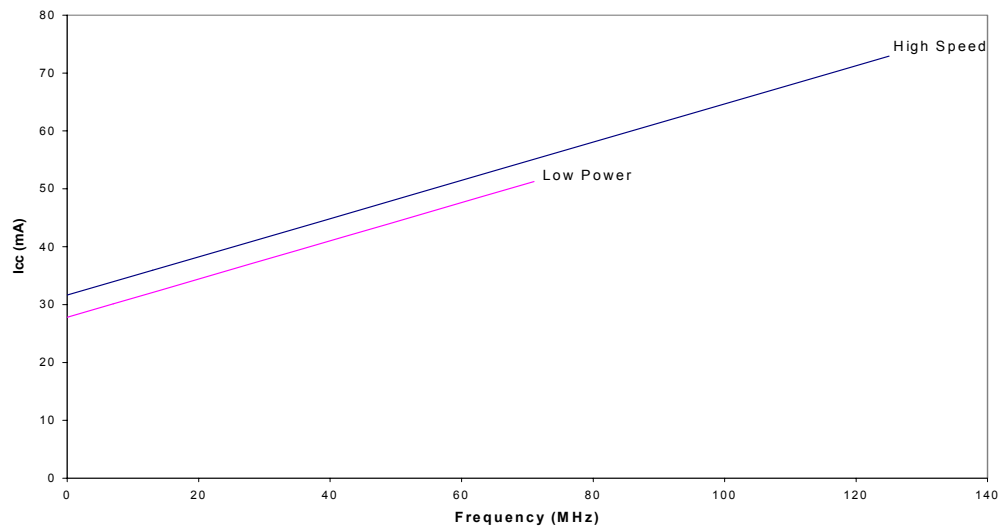
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
 $V_{CC} = 5.0V$, $T_A = \text{Room Temperature}$

CY37384


The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
 $V_{CC} = 5.0V$, $T_A = \text{Room Temperature}$

Typical 3.3V Power Consumption (continued)
CY37064V


The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
 $V_{CC} = 3.3V$, $T_A = \text{Room Temperature}$

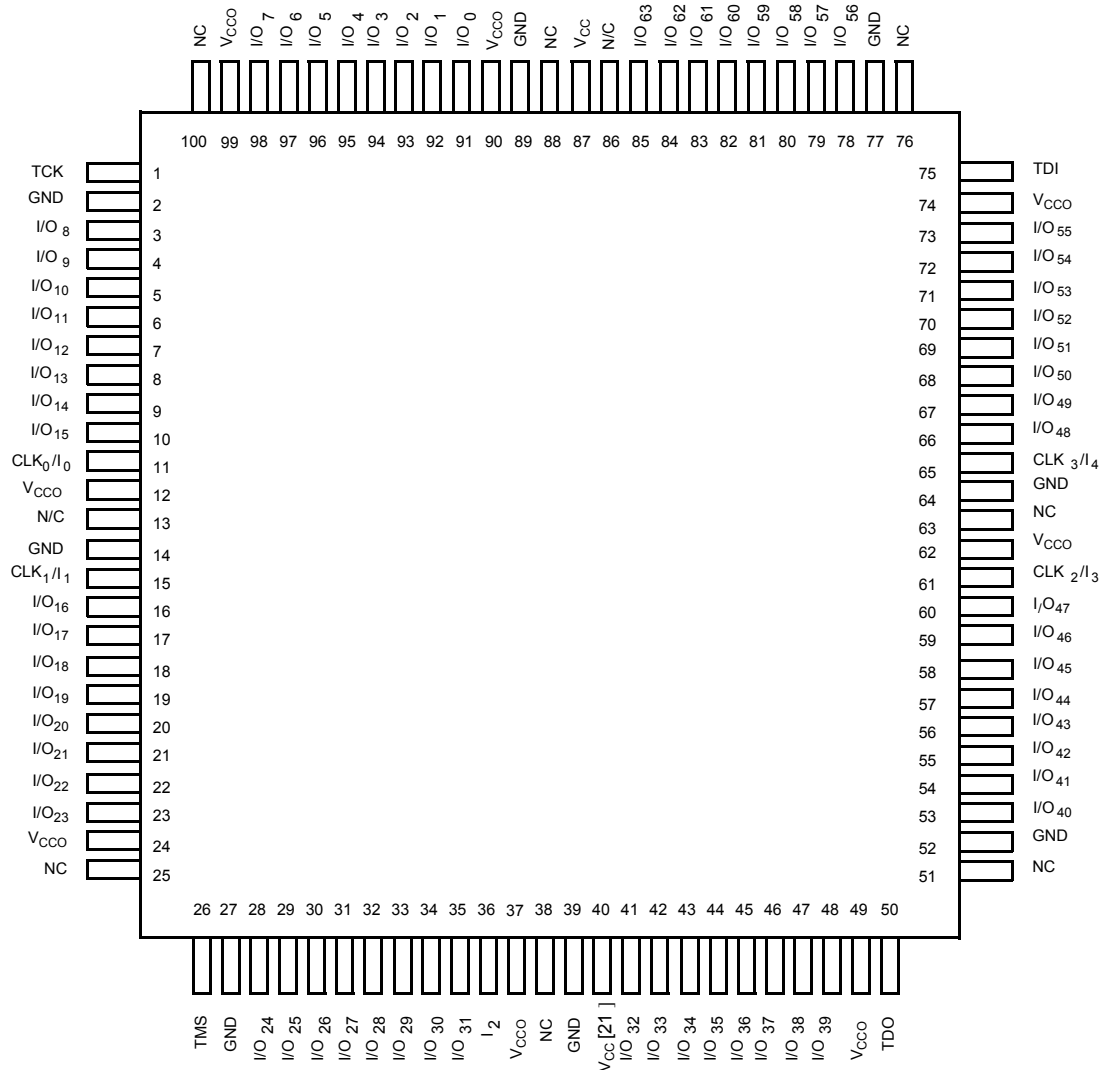
CY37128V


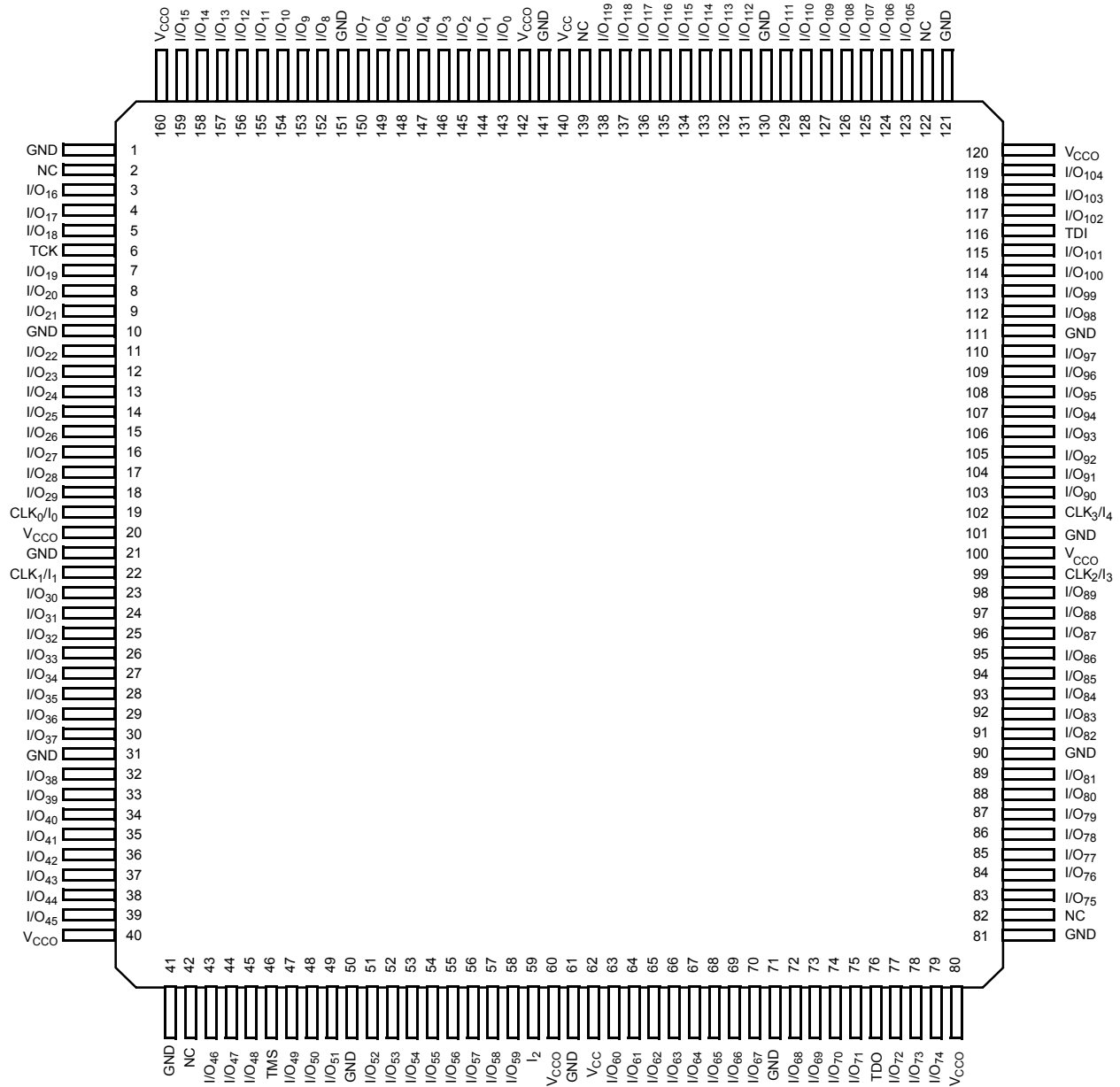
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
 $V_{CC} = 3.3V$, $T_A = \text{Room Temperature}$

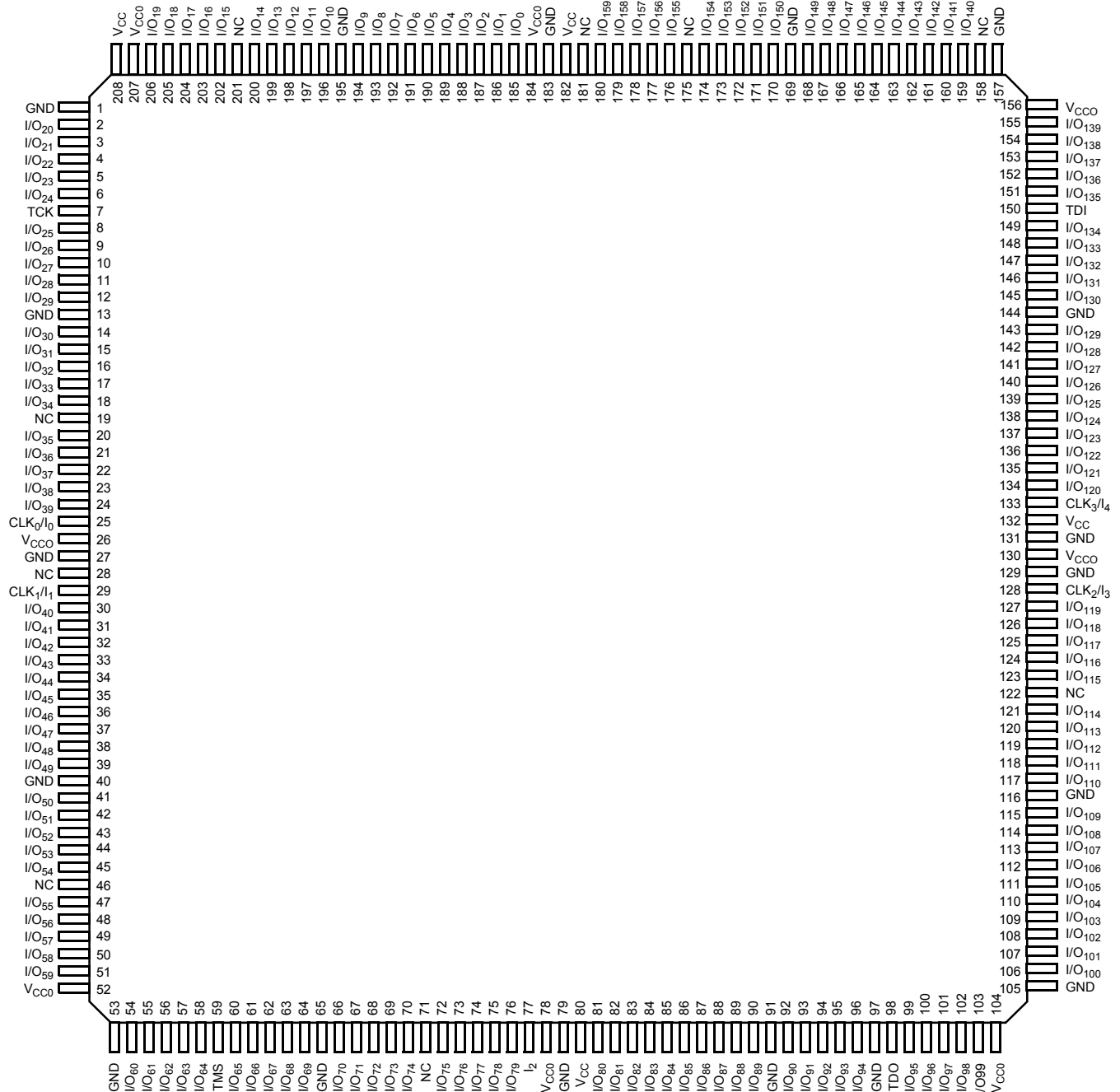
Pin Configurations^[20] (continued)

100-lead TQFP (A100)

Top View



Pin Configurations^[20] (continued)
**160-Lead TQFP (A160) for CY37192(V)
Top View**


Pin Configurations^[20] (continued)
**208-Lead PQFP (N208) / CQFP (U208)
Top View**


Pin Configurations^[20] (continued)
**292-Ball PBGA (BG292)
Top View**

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	
A	GND	I/O ₂₁	NC	I/O ₁₆	I/O ₁₂	I/O ₉	I/O ₇	I/O ₄	I/O ₀	I/O ₁₉₀	I/O ₁₈₉	I/O ₁₈₆	I/O ₁₈₂	NC	I/O ₁₇₈	I/O ₁₇₅	NC	NC	I/O ₁₆₉	I/O ₁₆₈	A
B	I/O ₂₃	I/O ₂₀	I/O ₁₉	I/O ₁₈	I/O ₁₅	I/O ₁₁	I/O ₈	I/O ₅	I/O ₁	I/O ₁₉₁	I/O ₁₈₇	I/O ₁₈₅	I/O ₁₈₁	NC	NC	I/O ₁₇₄	I/O ₁₇₁	I/O ₁₇₀	NC	I/O ₁₆₆	B
C	NC	NC	I/O ₂₂	NC	I/O ₁₇	I/O ₁₄	I/O ₁₀	I/O ₆	I/O ₂	NC	I/O ₁₈₈	I/O ₁₈₄	I/O ₁₈₀	I/O ₁₇₉	I/O ₁₇₆	I/O ₁₇₃	I/O ₁₇₂	I/O ₁₆₇	I/O ₁₆₅	I/O ₁₆₂	C
D	I/O ₂₄	NC	NC	GND	NC	V _{CC0}	I/O ₁₃	GND	I/O ₃	NC	V _{CC}	I/O ₁₈₃	GND	I/O ₁₇₇	V _{CC0}	NC	GND	I/O ₁₆₄	TDI	I/O ₁₆₀	D
E	I/O ₂₇	I/O ₂₆	I/O ₂₅	NC													I/O ₁₆₃	I/O ₁₆₁	I/O ₁₅₉	I/O ₁₅₆	E
F	I/O ₃₀	TCK	I/O ₂₈	V _{CC0}													V _{CC0}	I/O ₁₅₈	NC	I/O ₁₅₄	F
G	I/O ₃₃	I/O ₃₂	I/O ₃₁	I/O ₂₉													I/O ₁₅₇	I/O ₁₅₅	I/O ₁₅₃	I/O ₁₅₂	G
H	I/O ₃₅	NC	I/O ₃₄	GND	GND												GND	I/O ₁₅₁	I/O ₁₅₀	I/O ₁₄₉	H
J	I/O ₃₉	I/O ₃₈	I/O ₃₇	I/O ₃₆	GND												I/O ₁₄₈	I/O ₁₄₇	I/O ₁₄₆	I/O ₁₄₅	J
K	I/O ₄₂	I/O ₄₀	I/O ₄₁	V _{CC}	GND												I/O ₁₄₄	CLK ₃ /I ₄	NC	NC	K
L	I/O ₄₃	I/O ₄₄	I/O ₄₅	I/O ₄₆	GND												V _{CC}	CLK ₂ /I ₃	I/O ₁₄₃	NC	L
M	I/O ₄₇	CLK ₀ /I ₀	CLK ₁ /I ₁	I/O ₄₈	GND												I/O ₁₃₉	I/O ₁₄₀	I/O ₁₄₁	I/O ₁₄₂	M
N	I/O ₄₉	I/O ₅₀	I/O ₅₁	GND	GND												GND	I/O ₁₃₆	I/O ₁₃₇	I/O ₁₃₈	N
P	I/O ₅₂	I/O ₅₃	I/O ₅₅	I/O ₅₈													I/O ₁₃₁	I/O ₁₃₃	I/O ₁₃₄	I/O ₁₃₅	P
R	I/O ₅₄	I/O ₅₆	I/O ₅₉	V _{CC0}													V _{CC0}	I/O ₁₃₀	NC	I/O ₁₃₂	R
T	I/O ₅₇	I/O ₆₀	I/O ₆₂	I/O ₆₅													I/O ₁₂₄	I/O ₁₂₇	I/O ₁₂₈	I/O ₁₂₉	T
U	I/O ₆₁	I/O ₆₃	I/O ₆₆	GND	I/O ₇₆	V _{CC0}	I/O ₈₂	GND	I/O ₉₁	V _{CC}	I/O ₉₈	I/O ₁₀₂	GND	I/O ₁₁₂	V _{CC0}	NC	GND	I/O ₁₂₃	I/O ₁₂₂	I/O ₁₂₆	U
V	I/O ₆₄	I/O ₆₇	I/O ₆₉	I/O ₇₅	I/O ₇₈	I/O ₈₁	I/O ₈₅	I/O ₈₈	I/O ₉₂	I ₂	I/O ₉₇	I/O ₁₀₁	I/O ₁₀₅	I/O ₁₀₉	I/O ₁₁₃	TD0	I/O ₁₁₄	I/O ₁₁₇	I/O ₁₂₁	I/O ₁₂₅	V
W	I/O ₆₈	I/O ₇₀	I/O ₇₂	I/O ₇₄	I/O ₇₉	I/O ₈₃	I/O ₈₆	I/O ₈₉	I/O ₉₃	I/O ₉₅	I/O ₉₆	I/O ₁₀₀	I/O ₁₀₄	I/O ₁₀₇	I/O ₁₁₀	NC	NC	I/O ₁₁₅	I/O ₁₁₈	I/O ₁₂₀	W
Y	I/O ₇₁	I/O ₇₃	I/O ₇₇	TMS	I/O ₈₀	I/O ₈₄	I/O ₈₇	I/O ₉₀	I/O ₉₄	NC	NC	I/O ₉₉	I/O ₁₀₃	I/O ₁₀₆	I/O ₁₀₈	I/O ₁₁₁	NC	NC	I/O ₁₁₆	I/O ₁₁₉	Y
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	

5.0V Ordering Information (continued)

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
64	154	CY37064P44-154AC	A44	44-Lead Thin Quad Flat Pack	Commercial
		CY37064P44-154JC	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P84-154JC	J83	84-Lead Plastic Leaded Chip Carrier	
		CY37064P100-154AC	A100	100-Lead Thin Quad Flat Pack	
		CY37064P44-154AI	A44	44-Lead Thin Quad Flat Pack	Industrial
		CY37064P44-154AXI	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37064P44-154JI	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P44-154JXI	J67	44-Lead Lead Free Plastic Leaded Chip Carrier	
		CY37064P84-154JI	J83	84-Lead Plastic Leaded Chip Carrier	
		CY37064P100-154AI	A100	100-Lead Thin Quad Flat Pack	
		5962-9951902QYA	Y67	44-Lead Ceramic Leadless Chip Carrier	Military
	125	CY37064P44-125AC	A44	44-Lead Thin Quad Flat Pack	Commercial
		CY37064P44-125AXC	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37064P44-125JC	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P44-125JXC	J67	44-Lead Lead Free Plastic Leaded Chip Carrier	
		CY37064P84-125JC	J83	84-Lead Plastic Leaded Chip Carrier	
		CY37064P100-125AC	A100	100-Lead Thin Quad Flat Pack	
		CY37064P100-125AXC	A100	100-Lead Lead Free Thin Quad Flat Pack	
		CY37064P44-125AI	A44	44-Lead Thin Quad Flat Pack	Industrial
		CY37064P44-125AXI	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37064P44-125JI	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P84-125JI	J83	84-Lead Plastic Leaded Chip Carrier	
		CY37064P100-125AI	A100	100-Lead Thin Quad Flat Pack	
		CY37064P100-125AXI	A100	100-Lead Lead Free Thin Quad Flat Pack	Military
		5962-9951901QYA	Y67	44-Lead Ceramic Leadless Chip Carrier	

5.0V Ordering Information (continued)

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
512	125	CY37512P208-125NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37512P256-125BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37512P352-125BGC	BG388	388-Ball Plastic Ball Grid Array	
	100	CY37512P208-100NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37512P256-100BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37512P352-100BGC	BG388	388-Ball Plastic Ball Grid Array	
		CY37512P208-100NI	N208	208-Lead Plastic Quad Flat Pack	Industrial
		CY37512P256-100BGI	BG292	292-Ball Plastic Ball Grid Array	
		CY37512P352-100BGI	BG388	388-Ball Plastic Ball Grid Array	
		5962-9952502QZC	U208	208-Lead Ceramic Quad Flat Pack	Military
	83	CY37512P208-83NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37512P256-83BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37512P352-83BGC	BG388	388-Ball Plastic Ball Grid Array	
		CY37512P208-83NI	N208	208-Lead Plastic Quad Flat Pack	Industrial
		CY37512P256-83BGI	BG292	292-Ball Plastic Ball Grid Array	
		CY37512P352-83BGI	BG388	388-Ball Plastic Ball Grid Array	
		5962-9952501QZC	U208	208-Lead Ceramic Quad Flat Pack	Military

3.3V Ordering Information

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
32	143	CY37032VP44-143AC	A44	44-Lead Thin Quad Flat Pack	Commercial
		CY37032VP44-143AXC	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37032VP48-143BAC	BA50	48-Ball Fine Pitch Ball Grid Array	
	100	CY37032VP44-100AC	A44	44-Lead Thin Quad Flat Pack	Commercial
		CY37032VP44-100AXC	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37032VP48-100BAC	BA50	48-Ball Fine Pitch Ball Grid Array	
		CY37032VP44-100AI	A44	44-Lead Thin Quad Flat Pack	Industrial
		CY37032VP44-100AXI	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37032VP48-100BAI	BA50	48-Ball Fine Pitch Ball Grid Array	
		CY37032VP44-100JI	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37032VP44-100JXI	J67	44-Lead Lead Free Plastic Leaded Chip Carrier	

3.3V Ordering Information (continued)

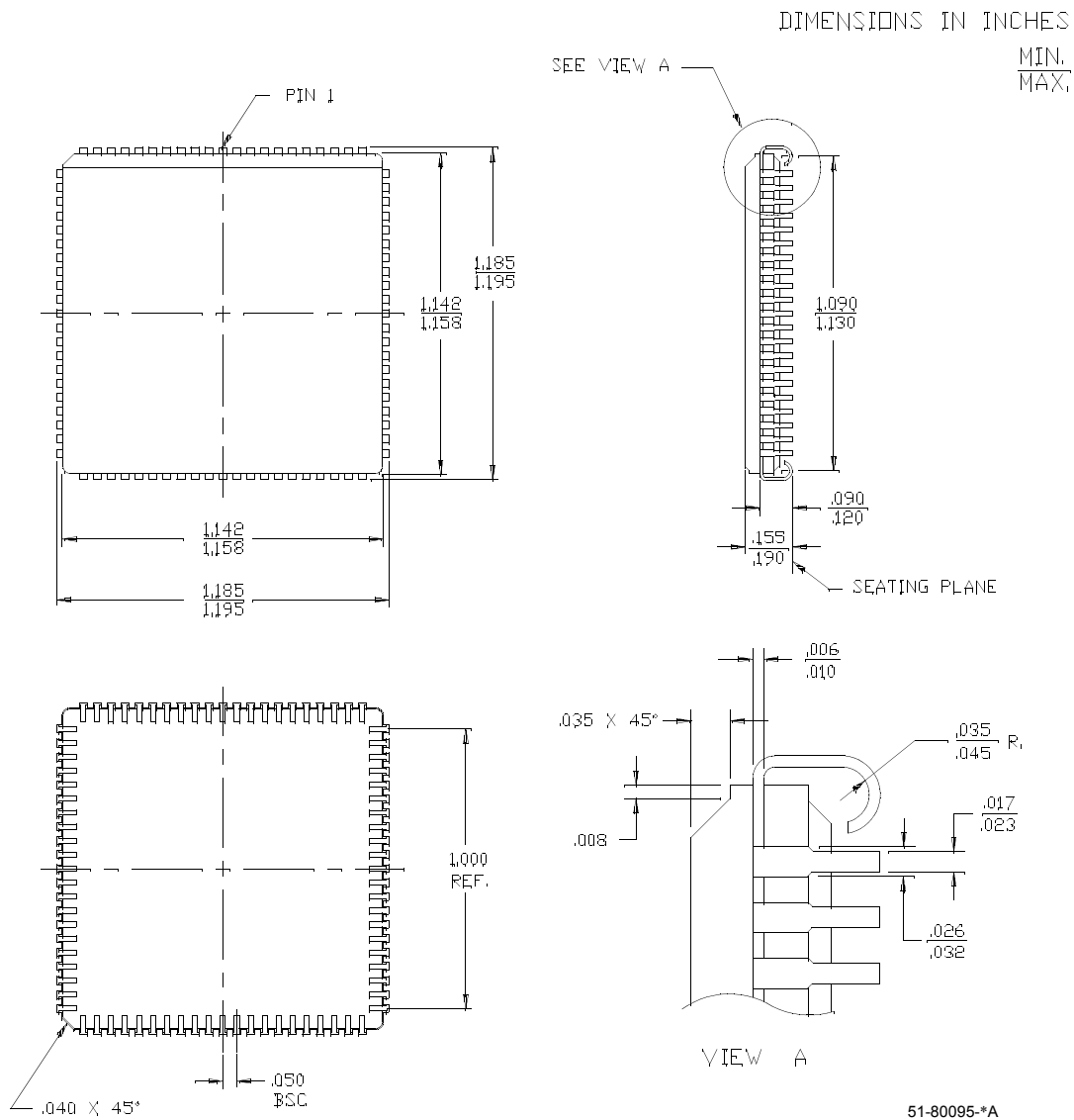
Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
64	143	CY37064VP44-143AC	A44	44-Lead Thin Quad Flatpack	Commercial
		CY37064VP44-143AXC	A44	44-Lead Lead Free Thin Quad Flatpack	
		CY37064VP48-143BAC	BA50	48-Ball Fine-Pitch Ball Grid Array	
		CY37064VP100-143AC	A100	100-Lead Thin Quad Flatpack	
		CY37064VP100-143AXC	A100	100-Lead Lead Free Thin Quad Flatpack	
		CY37064VP100-143BBC	BB100	100-Ball Fine-Pitch Ball Grid Array	
	100	CY37064VP44-100AC	A44	44-Lead Thin Quad Flatpack	Commercial
		CY37064VP44-100AXC	A44	44-Lead Lead Free Thin Quad Flatpack	
		CY37064VP48-100BAC	BA50	48-Ball Fine-Pitch Ball Grid Array	
		CY37064VP100-100AC	A100	100-Lead Thin Quad Flatpack	
		CY37064VP100-100AXC	A100	100-Lead Lead Free Thin Quad Flatpack	
		CY37064VP100-100BBC	BB100	100-Ball Fine-Pitch Ball Grid Array	
		CY37064VP44-100AI	A44	44-Lead Thin Quad Flatpack	Industrial
		CY37064VP44-100AXI	A44	44-Lead Lead Free Thin Quad Flatpack	
		CY37064VP48-100BAI	BA50	48-Ball Fine-Pitch Ball Grid Array	
		CY37064VP100-100BBI	BB100	100-Ball Fine-Pitch Ball Grid Array	
		CY37064VP100-100AI	A100	100-Lead Thin Quad Flatpack	
		CY37064VP100-100AXI	A100	100-Lead Lead Free Thin Quad Flatpack	
		5962-9952001QYA	Y67	44-Lead Ceramic Leaded Chip Carrier	Military
128	125	CY37128VP100-125AC	A100	100-Lead Thin Quad Flat Pack	Commercial
		CY37128VP100-125AXC	A100	100-Lead Lead Free Thin Quad Flat Pack	
		CY37128VP100-125BBC	BB100	100-Ball Fine-Pitch Ball Grid Array	
		CY37128VP160-125AC	A160	160-Lead Thin Quad Flat Pack	Industrial
		CY37128VP160-125AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
		CY37128VP160-125AI	A160	160-Lead Thin Quad Flat Pack	
		CY37128VP160-125AXI	A160	160-Lead Lead Free Thin Quad Flat Pack	
	83	CY37128VP100-83AC	A100	100-Lead Thin Quad Flat Pack	Commercial
		CY37128VP100-83AXC	A100	100-Lead Lead Free Thin Quad Flat Pack	
		CY37128VP100-83BBC	BB100	100-Ball Fine-Pitch Ball Grid Array	
		CY37128VP160-83AC	A160	160-Lead Thin Quad Flat Pack	
		CY37128VP160-83AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
		CY37128VP100-83AI	A100	100-Lead Thin Quad Flat Pack	Industrial
		CY37128VP100-83AXI	A100	100-Lead Lead Free Thin Quad Flat Pack	
		CY37128VP100-83BBI	BB100	100-Ball Fine-Pitch Ball Grid Array	
		CY37128VP160-83AI	A160	160-Lead Thin Quad Flat Pack	
		CY37128VP160-83AXI	A160	160-Lead Lead Free Thin Quad Flat Pack	
		5962-9952201QYA	Y84	84-Lead Ceramic Leaded Chip Carrier	Military
192	100	CY37192VP160-100AC	A160	160-Lead Thin Quad Flat Pack	Commercial
		CY37192VP160-100AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
	66	CY37192VP160-66AC	A160	160-Lead Thin Quad Flat Pack	Commercial
		CY37192VP160-66AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
		CY37192VP160-66AI	A160	160-Lead Thin Quad Flat Pack	Industrial

3.3V Ordering Information (continued)

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
256	100	CY37256VP160-100AC	A160	160-Lead Thin Quad Flat Pack	Commercial
		CY37256VP160-100AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
		CY37256VP208-100NC	N208	208-Lead Plastic Quad Flat Pack	
		CY37256VP256-100BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37256VP256-100BBC	BB256	256-Ball Fine-Pitch Ball Grid Array	
		CY37256VP160-100AI	A160	160-Lead Thin Quad Flat Pack	
		CY37256VP160-100AXI	A160	160-Lead Lead Free Thin Quad Flat Pack	
	66	CY37256VP160-66AC	A160	160-Lead Thin Quad Flat Pack	Commercial
		CY37256VP160-66AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
		CY37256VP208-66NC	N208	208-Lead Plastic Quad Flat Pack	
		CY37256VP256-66BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37256VP256-66BBC	BB256	256-Ball Fine-Pitch Ball Grid Array	
		CY37256VP160-66AI	A160	160-Lead Thin Quad Flat Pack	Industrial
		CY37256VP256-66BGI	BG292	292-Ball Plastic Ball Grid Array	
		CY37256VP256-66BBI	BB256	256-Ball Fine-Pitch Ball Grid Array	
		5962-9952401QZC	U162	160-Lead Ceramic Quad Flat Pack	Military
384	83	CY37384VP208-83NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37384VP256-83BGC	BG292	292-Ball Plastic Ball Grid Array	
	66	CY37384VP208-66NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37384VP256-66BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37384VP208-66NI	N208	208-Lead Plastic Quad Flat Pack	Industrial
		CY37384VP256-66BGI	BG292	292-Ball Plastic Ball Grid Array	
512	83	CY37512VP208-83NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37512VP256-83BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37512VP352-83BGC	BG388	388-Ball Plastic Ball Grid Array	
		CY37512VP400-83BBC	BB400	400-Ball Fine-Pitch Ball Grid Array	
	66	CY37512VP208-66NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37512VP256-66BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37512VP352-66BGC	BG388	388-Ball Plastic Ball Grid Array	
		CY37512VP400-66BBC	BB400	400-Ball Fine-Pitch Ball Grid Array	
		CY37512VP208-66NI	N208	208-Lead Plastic Quad Flat Pack	Industrial
		CY37512VP256-66BGI	BG292	292-Ball Plastic Ball Grid Array	
		CY37512VP352-66BGI	BG388	388-Ball Plastic Ball Grid Array	
		CY37512VP400-66BBI	BB400	400-Ball Fine-Pitch Ball Grid Array	
		5962-9952601QZC	U208	208-Lead Ceramic Quad Flat Pack	Military

Package Diagrams (continued)

84-Lead Ceramic Leaded Chip Carrier Y84

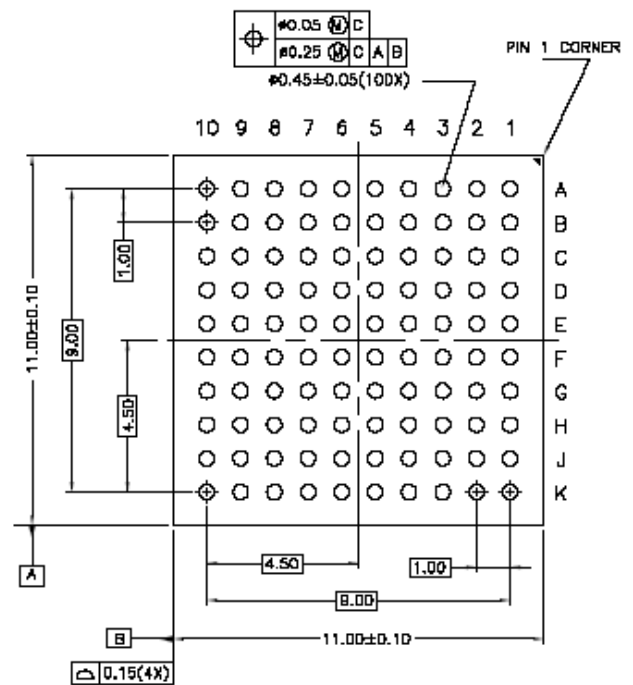
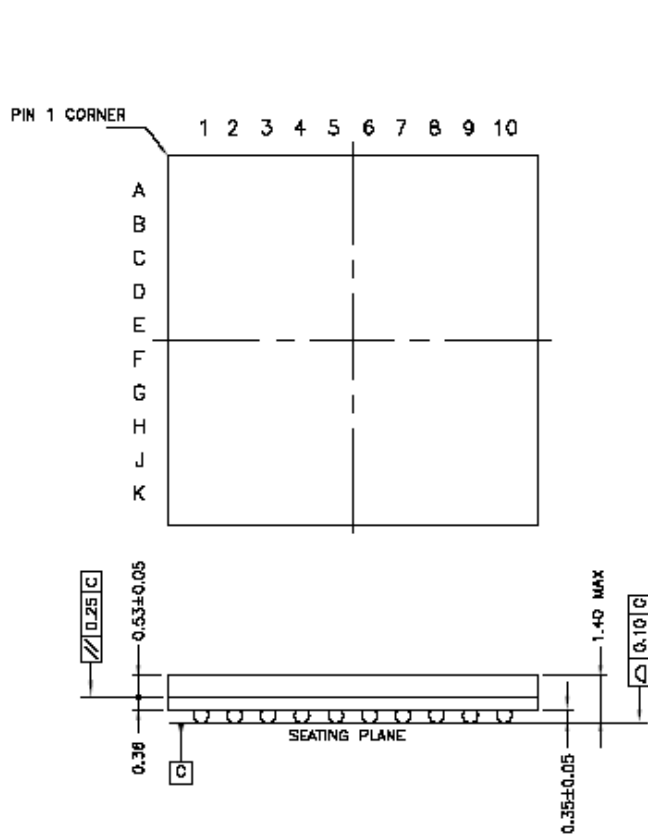


Package Diagrams (continued)

100-Ball Thin Ball Grid Array (11 x 11 x 1.4 mm) BB100

TOP VIEW

BOTTOM VIEW



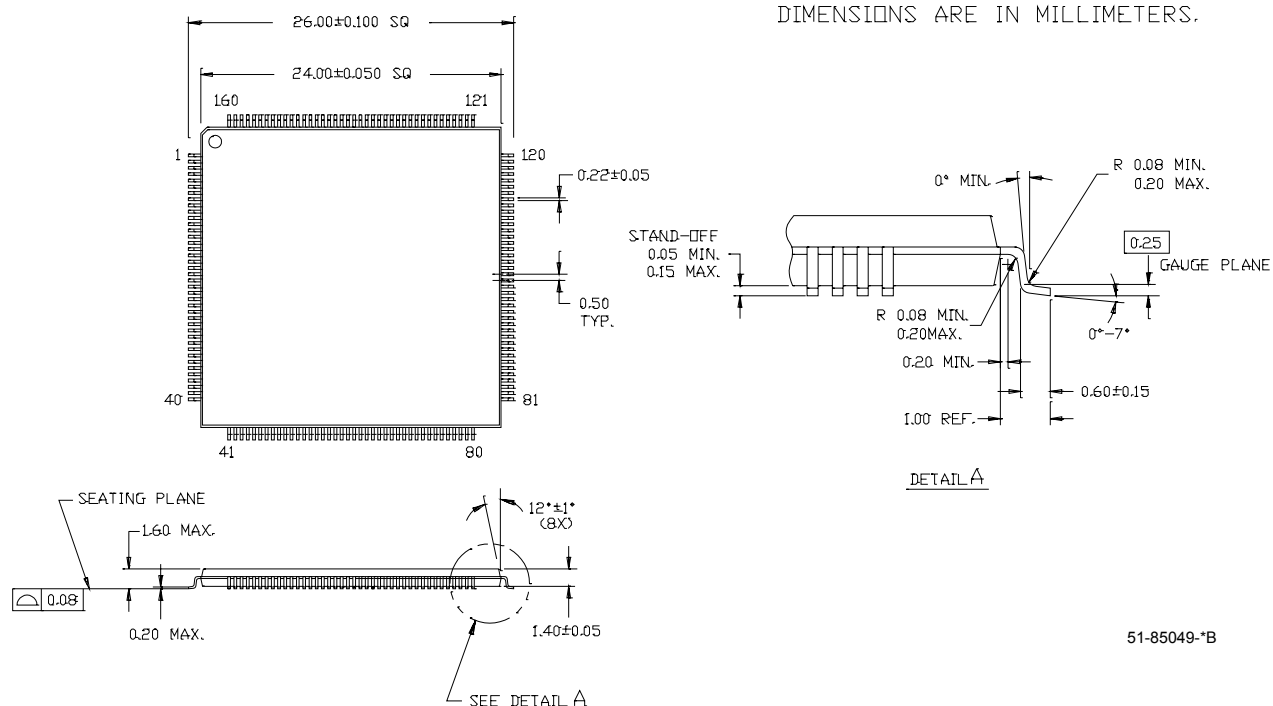
51-85107-B



Ultra37000 CPLD Family

Package Diagrams (continued)

160-Lead Lead (Pb)-Free Thin Plastic Quad Flat Pack (24 x 24 x 1.4 mm) (TQFP) A160



51-85049-*B